



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Gurtej S. Sandhu et al.

Title: METHOD FOR FORMING A METALLIZATION LAYER

Docket No.: 303.085US4

Serial No.: 09/652,619

Filed: August 31, 2000

Due Date: May 28, 2006

Examiner: Renee Berry

Group Art Unit: 2818

Customer No.: 21186

Confirmation No.: 4342

Commissioner for Patents

Notice of Allowance Date:

Attn: MAIL STOP ISSUE FEE

February 28, 2006

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the attached:

- A check in the amount of \$70.00 to cover the remainder of Large Entity Issue Fee Payment.
- Amendment Under 37 C.F.R. § 1.312 (20 pgs).
- Issue Fee Transmittal (Form PTOL-85).
- Communication Re: Fee Address (1 page).
- Request to Apply Previously Paid Issue Fee
- A return postcard.

Please charge any additional required fees for the Issue Fee Payment or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

By Marvin L. Beekman

Customer Number: 21186

Marvin L. Beekman

Reg. No. 38,377

MLB:CMG:cmb

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Attn – MAIL STOP ISSUE FEE, P.O. Box 1450, Alexandria, VA 22313-1450, on this 26 day of May, 2006.

Christopher M. BACON
Name


Signature